## **MOSFET** – N-Channel, SUPERFET<sup>®</sup>, FRFET<sup>®</sup>

600 V, 47 A, 73 m $\Omega$ 

# FCH47N60F

### Description

SUPERFET MOSFET is ON Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance,dv/dt rate and higher avalanche energy. Consequently, SUPERFET MOSFET is very suitable for the switching power applications such as PFC, server / telecom power, FPD TV power, ATX power and industrial power applications. SUPERFET FRFET MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

### Features

- $650 \text{ V} @ \text{T}_{\text{J}} = 150^{\circ}\text{C}$
- Typ.  $R_{DS(on)} = 58 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 210 nC)
- Low Effective Output Capacitance (Typ. Cosseff. = 420 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

### Applications

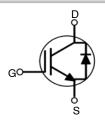
- Solar Inventer
- AC-DC Power Supply



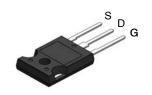
## **ON Semiconductor®**

### www.onsemi.com

V <sub>DS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX		
600 V	73 m $\Omega$ @ 10 V	47 A		

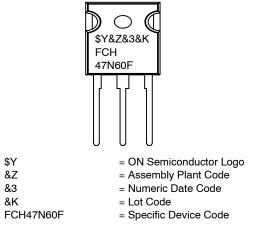


N-CHANNEL MOSFET



TO-247-3LD CASE 340CK

#### MARKING DIAGRAM



### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Symbol	pol Parameter		FCH47N60F-F133	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		600	V	
Ι <sub>D</sub>	Drain Current –	-Continuous (T <sub>C</sub> = 25°C) -Continuous (T <sub>C</sub> = 100°C)	47 29.7	A A	
I <sub>DM</sub>	Drain Current	-Pulsed (Note 1)	141	А	
V <sub>GSS</sub>	Gate-Source Voltage		±30	V	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		1800	mJ	
I <sub>AR</sub>	Avalanche Current (Note 1)		47	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		41.7	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		50	V/ns	
P <sub>D</sub>	Power Dissipation	(T <sub>C</sub> = 25°C) –Derate Above 25°C	417 3.33	W W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to + 150	°C	
ΤL	Maximum Lead Temperature for Soldering Purpose, 1/8 from Case for 5 second		300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2.  $I_{AS} = 18 \text{ A}, V_{DD} = 50 \text{ V}, R_G = 25 \Omega$ , Starting  $T_J = 25 \text{ °C}$ 3.  $I_{SD} \leq 47 \text{ A}, \text{ di/dt} \leq 1200 \text{ A/}\mu\text{s}, V_{DD} \leq \text{BV}_{DSS}$ , Starting  $T_J = 25 \text{ °C}$ .

#### PACKAGE MARKING AND ORDERING INFORMATION

Device Marking Device		Package	ge Reel Size Tape Width		Quantity	
FCH47N60F	FCH47N60F-F133	TO-247-3	-	-	30 Units	

#### **THERMAL CHARACTERISTICS**

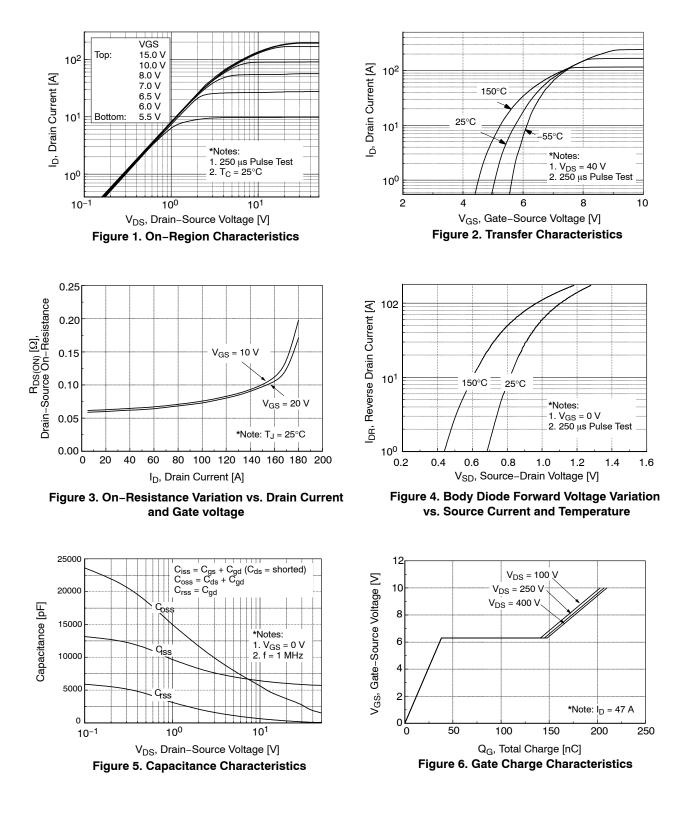
Symbol Parameter		Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max. (Note 34)	41.7	

### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

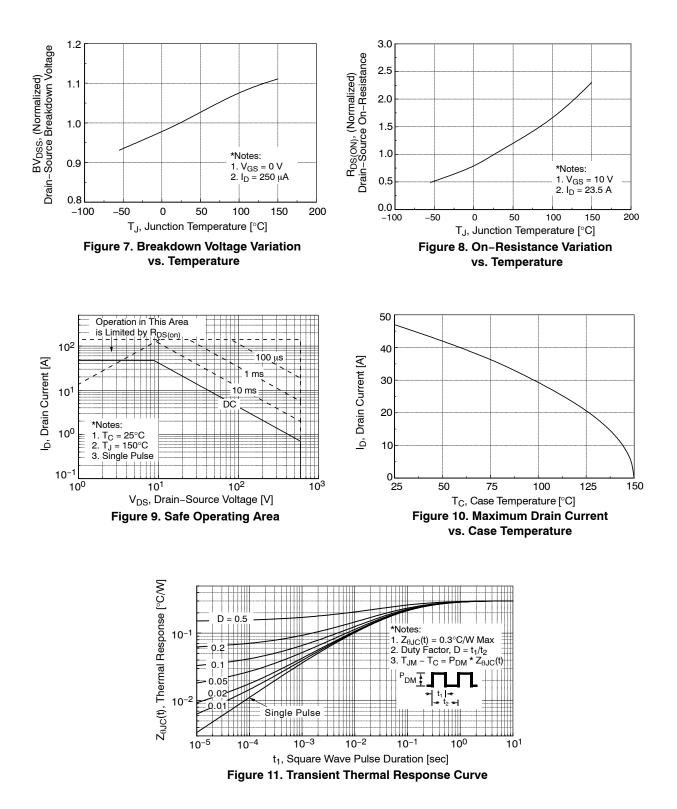
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARA	ACTERISTICS					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D$ = 250 $\mu A,V_{GS}$ = 0 V, $T_J$ = 25°C	600	-	-	V
		$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V, \ T_J = 150^\circ\text{C}$	-	650	_	V
$\begin{array}{c} \Delta \text{BV}_{\text{DSS}} \\ /  \Delta \text{T}_{\text{J}} \end{array}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 µA, Referenced to 25°C	-	0.6	_	V/∘C
$BV_{DS}$	Drain-Source Avalanche Breakdown Voltage	I <sub>D</sub> = 47 A, V <sub>GS</sub> = 0 V	-	700	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	10	μA
		$V_{DS} = 480 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$	-	-	100	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30$ V, $V_{DS} = 0$ V	-	-	-100	nA
ON CHARAG	CTERISTICS	·				
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	3	-	5	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 23.5 A	-	0.062	0.073	Ω
<b>9</b> FS	Forward Transconductance	$V_{DS} = 40 \text{ V}, I_{D} = 23.5 \text{ A}$	-	40	-	S
OYNAMIC C	HARACTERISTICS	•	•			
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 25 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$	-	5900	8000	pF
C <sub>oss</sub>	Output Capacitance	f = 1 MHz	-	3200	4200	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	250	_	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	160	_	pF
C <sub>oss</sub> eff.	Effective Output Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$	-	420	-	pF
WITCHING	CHARACTERISTICS					1
t <sub>d(on)</sub>	Turn-On Delay Time	$\label{eq:VDD} \begin{array}{l} V_{DD} = 300 \; V, \; I_D = 47 \; A, \\ R_G = 25 \; \Omega \\ (Note \; 4) \end{array}$	-	185	430	ns
t <sub>r</sub>	Turn-On Rise Time		_	210	450	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		_	520	1100	ns
t <sub>f</sub>	Turn-Off Fall Time		_	75	160	ns
Qg	Total Gate Charge	V <sub>DS</sub> = 480 V, I <sub>D</sub> = 47 A <sub>,</sub>	-	210	270	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>GS</sub> = 10 V (Note 4)	_	38	_	nC
Q <sub>gd</sub>	Gate-Drain Charge		_	110	_	nC
RAIN-SOU	RCE DIODE CHARACTERISTICS AND N	IAXIMUM RATINGS				
۱ <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	_	47	Α
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	141	А
V <sub>SD</sub>	Source to Drain Diode Voltage	$V_{GS} = 0 V, I_{S} = 47 A$	-	-	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 47 A,	-	240	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100 A/μs	_	2.04	_	μC

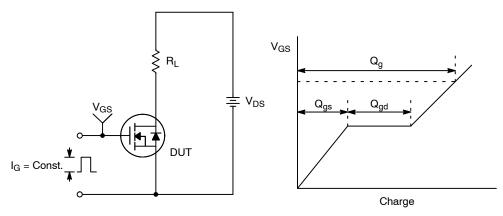
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially Independent of Operating Temperature Typical Characteristics.

### **TYPICAL CHARACTERISTICS**



### **TYPICAL CHARACTERISTICS**







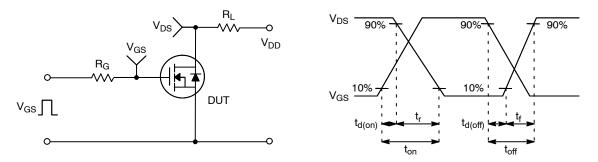


Figure 13. Resistive Switching Test Circuit & Waveforms

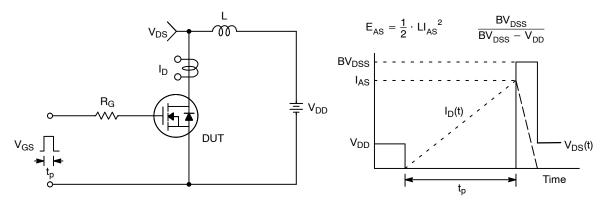


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

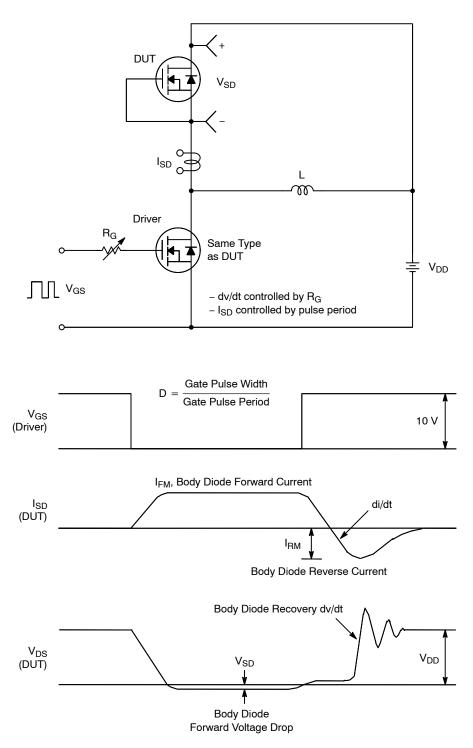


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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